

Petitioner Bluehouse Global Ltd.

Ex. 1006



(12) **United States Patent**
Miyazaki et al.

(10) **Patent No.:** **US 6,784,453 B2**
(45) **Date of Patent:** **Aug. 31, 2004**

(54) **SEMICONDUCTOR DEVICE AND METHOD FOR PRODUCING THE SAME**

FOREIGN PATENT DOCUMENTS

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Akane Murakami, Kanagawa (JP);
Satoshi Teramoto, Kanagawa (JP)

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(73) Assignee: **Semiconductor Energy Laboratory Co., Ltd.**, Kanagawa-ken (JP)

(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

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(21) Appl. No.: **10/336,805**

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(22) Filed: **Jan. 6, 2003**

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(65) **Prior Publication Data**

US 2003/0132482 A1 Jul. 17, 2003

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Related U.S. Application Data

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(62) Division of application No. 09/782,299, filed on Feb. 14, 2001, now Pat. No. 6,569,719, which is a division of application No. 08/635,283, filed on Apr. 19, 1996, now Pat. No. 6,201,281, which is a continuation of application No. 08/270,773, filed on Jul. 5, 1994, now abandoned.

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(30) **Foreign Application Priority Data**

Jul. 7, 1993 (JP) 5-192829

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(51) **Int. Cl.**⁷ **H01L 31/036**

(57) **ABSTRACT**

(52) **U.S. Cl.** **257/49; 257/72; 257/347**

In the production of thin film transistor (TFT), a gate insulating film is formed to cover an active layer, a titanium nitride film is formed on the gate insulating film, and an aluminum film used as the gate electrode is formed on the titanium nitride film. The resulted configuration prevents the etching of the aluminum film from the insulating film side even if the etchant of aluminum enters the recessed portion at the edge of the active layer during the patterning of the gate electrode. Also in the anodizing process, when an oxide film is formed on the surface of the aluminum film, the oxidation of aluminum from the gate insulating film side is prevented even when the electrolyte solution enters the recessed portion at the edge of the active layer.

(58) **Field of Search** 257/49, 72-74, 257/347, 348; 438/96-97, 482

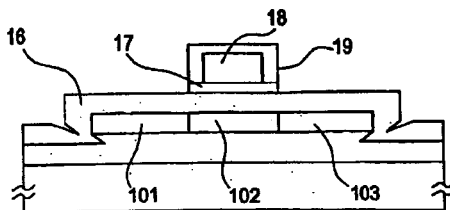
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27 Claims, 4 Drawing Sheets



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FIG. 1A

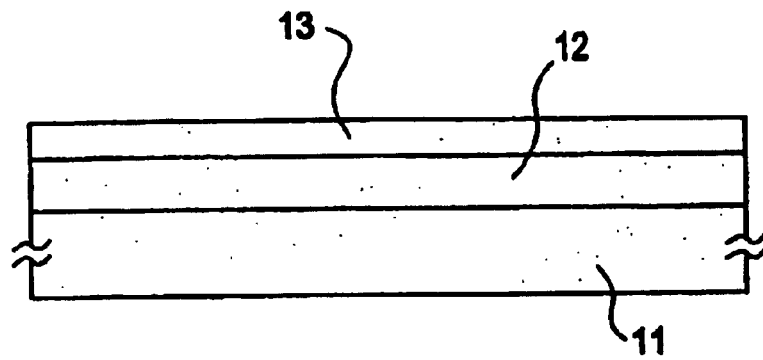


FIG. 1B

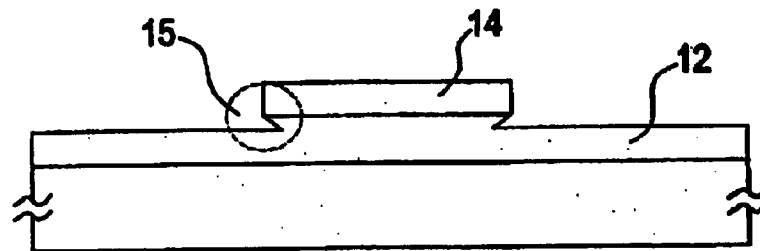


FIG. 1C

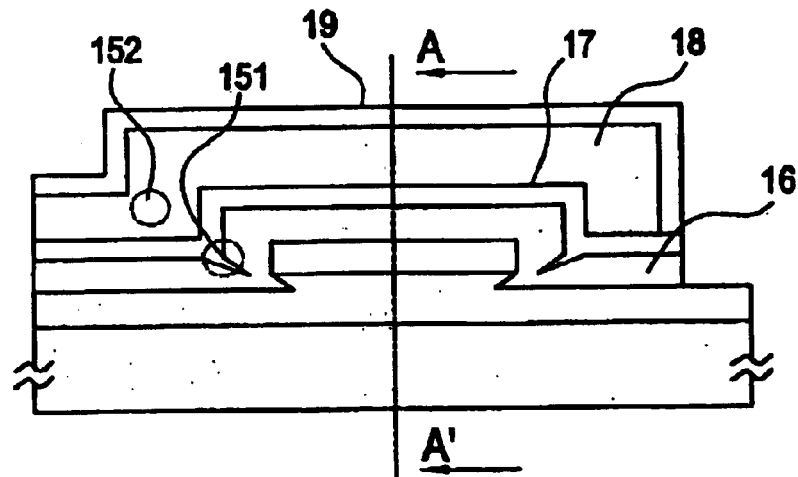


FIG. 1D

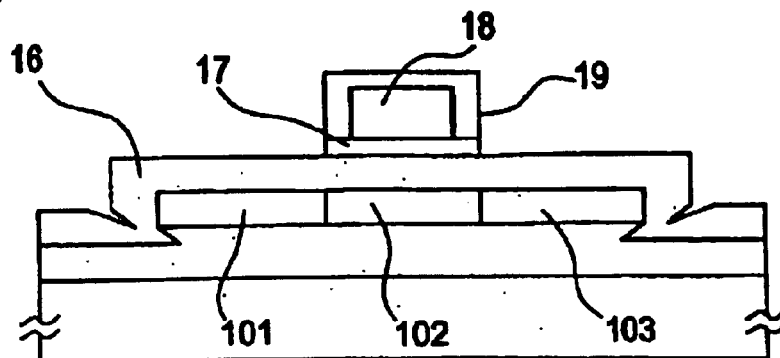


FIG. 2A
PRIOR ART

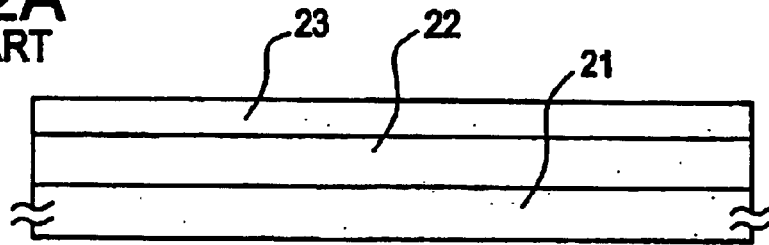


FIG. 2B
PRIOR ART

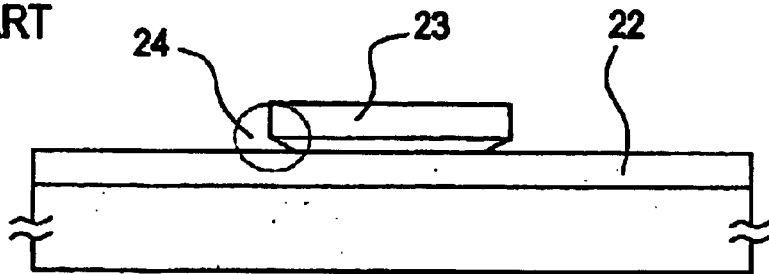


FIG. 2C
PRIOR ART

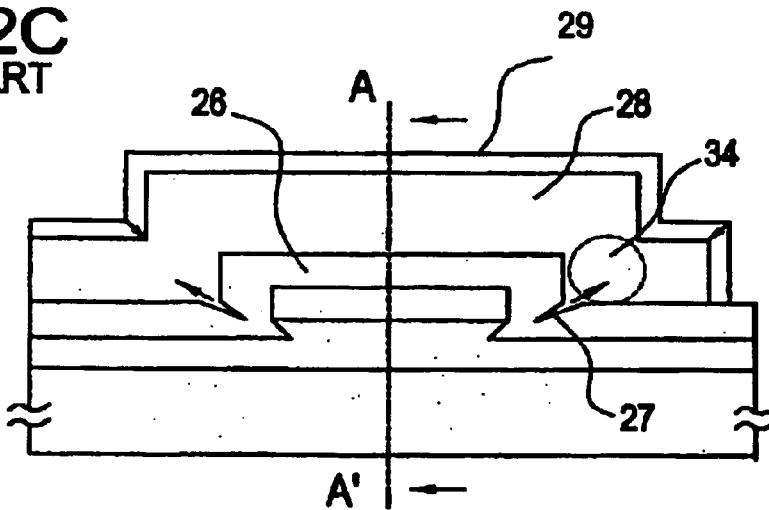
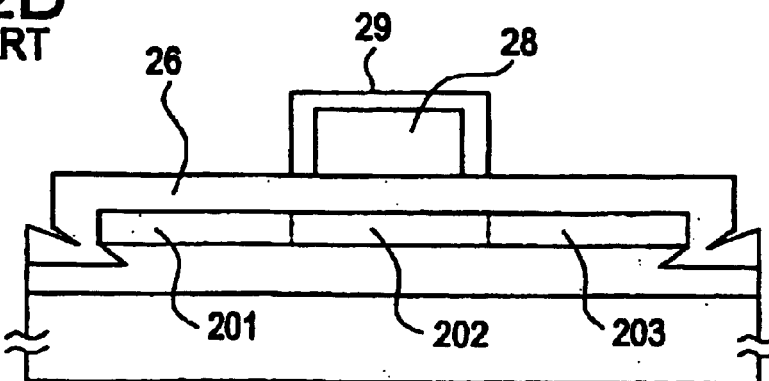


FIG. 2D
PRIOR ART



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